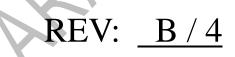


PARA LIGHT ELECTRONICS CO., LTD.

11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan,Tel: 886-2-2225-3733Fax: 886-2-2225-4800E-mail: para@para.com.twhttp://www.para.com.tw

DATA SHEET

PART NO.: L-S110JRCT



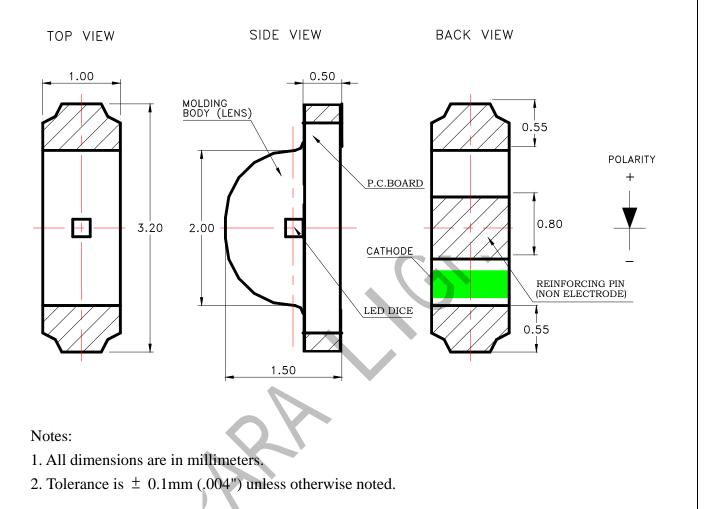
CUSTOMER'S APPROVAL :		DCC :	
DRAWING NO. : DS-73-06-0007	DATE : 2020-1-17	PAGE	1 of 12



Part No. : L-S110JRCT

REV:B / 4

PACKAGE OUTLINE DIMENSIONS



• Features

- * Side looking special for LCD backlight.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Infrared and Wave soldering reflow solder processes.
- * EIA STD package.
- * I.C. compatible.
- * Pb free product.
- * Meet RoHS Green Product.

DRAWING NO. : DS-73-06-0007

DATE : 2020-1-17 PAGE 2 of 12



Part No. : L-S110JRCT

REV:B / 4

• Chip Materials

- * Dice Material : AlInGaP
- * Light Color : Super Red
- * Lens Color : Water Clear

• Absolute Maximum Ratings(Ta=25°C)

Symbol	Parameter	Rating	Unit
PD	Power Dissipation	75	mW
IPF	Peak Forward Current	80	mA
(1/10 Duty Cycle, 0.1ms Pulse Width)		80	mA
IF	Continuous Forward Current	25	mA
VR	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold(HBM) ^{Note A}	2000	V
Topr	Operating Temperature Range	-40 ~ +85	°C
Tstg	Storage Temperature Range	-40 ~ +85	°C

Note A :

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

• Electro-Optical Characteristics(Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	28.0	60.0		mcd	IF=20mA
Viewing Angle	2 θ 1/2		130		deg	Note 2
Peak Emission Wavelength	λp		639		nm	Measurement @Peak
Dominant Wavelength	λd		631		nm	IF=20mA
Spectral Line Half-Width	Δλ		17		nm	
Forward Voltage	VF		1.9	2.6	V	IF =20mA
Reverse Current	IR			10	μA	VR = 5V

DRAWING NO. : DS-73-06-0007

DATE : 2020-1-17 PAGE 3 of 12



Part No. : L-S110JRCT

REV:B / 4

• Bin Code List

Luminous Intensity(IV), Unit:mcd@20mA			
Bin Code	Min	Max	
N	28.0	45.0	
Р	45.0	71.0	
Q	71.0	112.0	

Tolerance of each bin are $\pm 15\%$

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

4. Caution in ESD :

Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. Major standard testing equipment by "Instrument System" Model : CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model : 2400.

DRAWING NO. : DS-73-06-0007

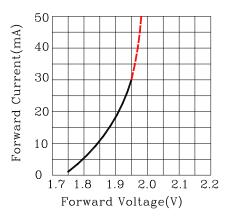


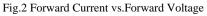
Part No. : L-S110JRCT

REV:B / 4

Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)





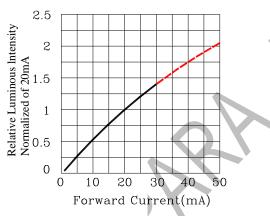
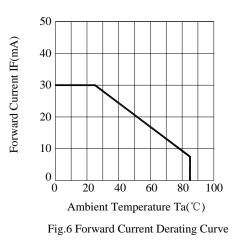
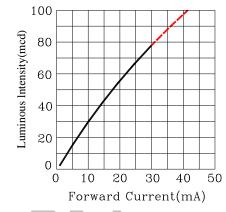


Fig.4 Relative Luminous Intensity vs.Forward Current







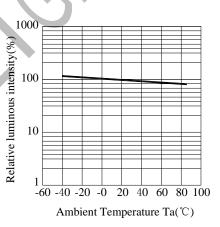
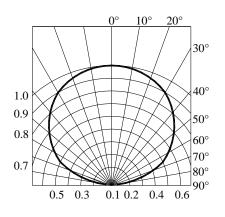


Fig.5 Luminous Intensity vs.Ambient Temperature





DRAWING NO. : DS-73-06-0007

DATE : 2020-1-17 PAGE

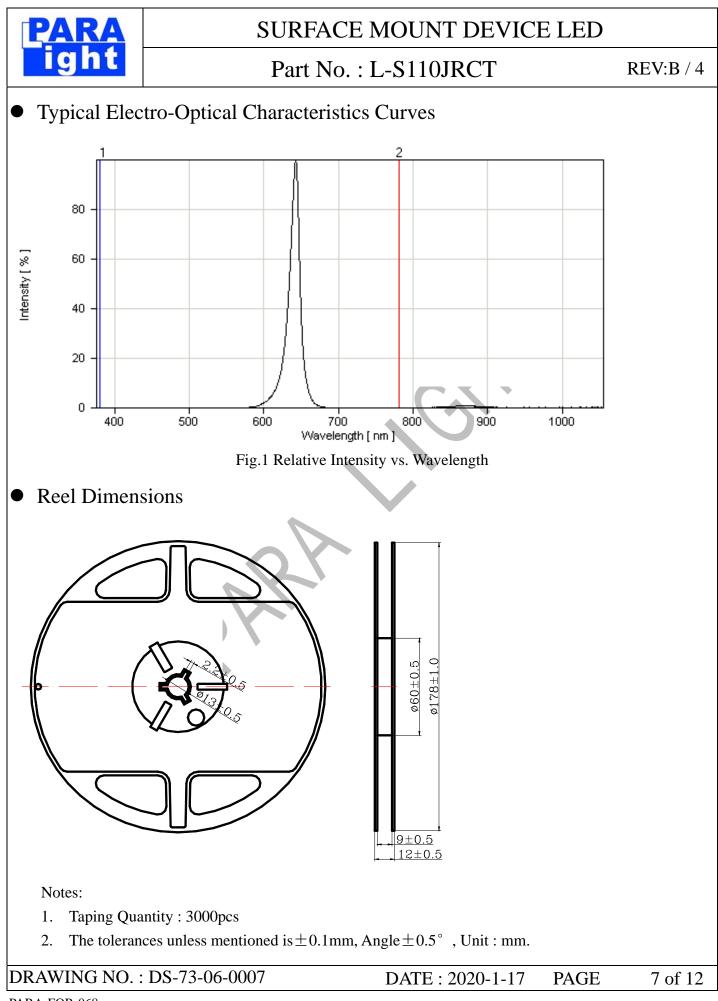


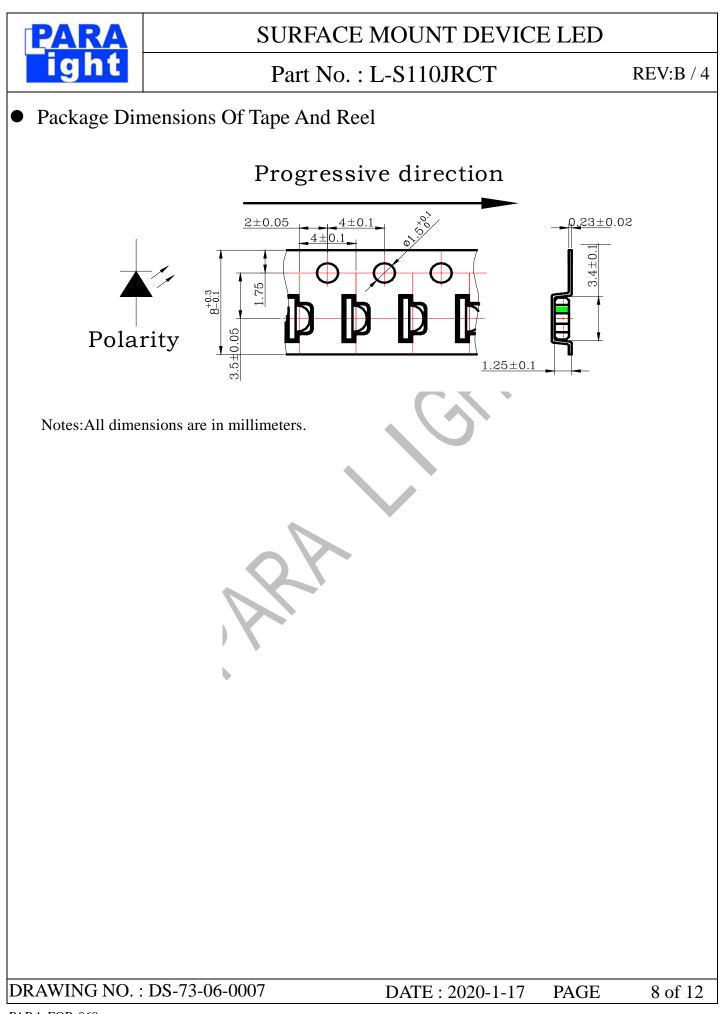
Part No. : L-S110JRCT

REV:B / 4

• Label Explanation 光鼎電子股份有限公司 PARA LIGHT ELECTRONICS CO., LTD PART NO: STOMER: PART NO: IV: LOT NO: VF: WD: **OUANTITY:** DATE CODE: QC: RoHS ITEM CODE:PARRA LIGHT PART NO: L-S110JRCT IV --- Luminous Intensity Code LOT NO: EM S L 12 09 0110 А В С D Е F A---EM: Emos Code B---S:SMD L---Local D---Year E---Month F---SPEC. PACKING QUANTITY OF BAG: 3000pcs for 150, 170, 110, 155, 115 series 4000pcs for 191 series 5000pcs for 192 series DATE CODE: 2012 09 10 G Η Ι G--- Year H--- Month I --- Day

DRAWING NO. : DS-73-06-0007







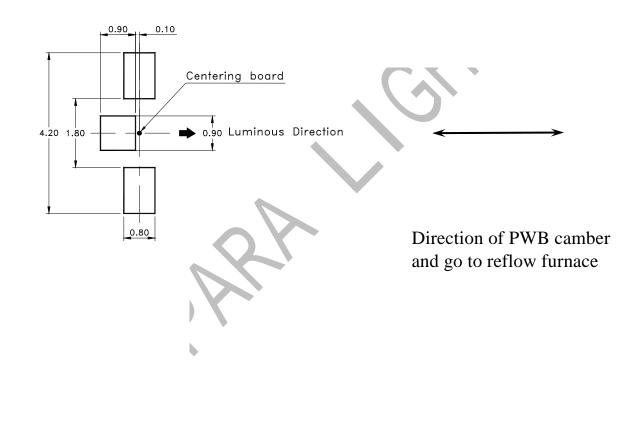
Part No. : L-S110JRCT

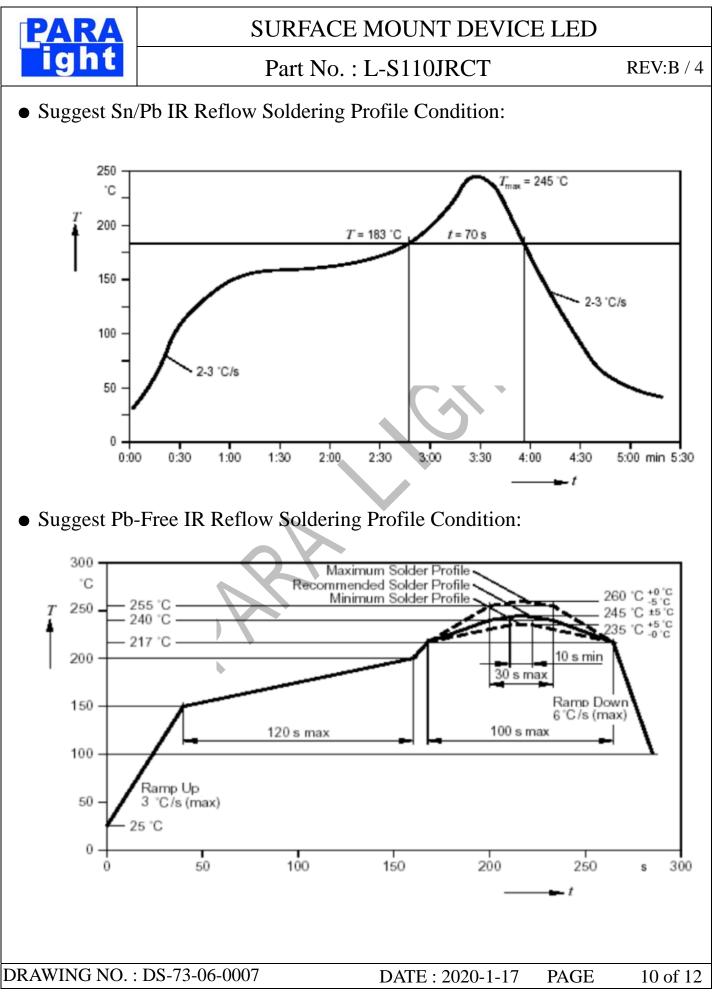
REV:B / 4

• Cleaning

- * If cleaning is required , use the following solutions for less than 1 minute and less than 40° C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

• Suggest Soldering Pad Dimensions





PARA-FOR-068



Part No. : L-S110JRCT

REV:B / 4

• CAUTIONS

1. Application Limitation :

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application).Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage :

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30° C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering :

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time : 10 sec Max. Soldering Iron : (Not recommended)

Temperature 300°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering. Wave soldering :

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

DRAWING NO. : DS-73-06-0007



Part No. : L-S110JRCT

REV:B / 4

4. Lead-Free Soldering

For Reflow Soldering :

- 1 Pre-Heat Temp:150-180°C,120sec.Max.
- 2 Soldering Temp:Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3 $\$ Peak Temperature:260 $^\circ\!C$, 5sec.
- 4 Reflow Repetition:2 Times Max.
- 5 ` Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu

For Soldering Iron (Not Recommended) :

- 1 \ Iron Tip Temp:350°C Max.
- 2 Soldering Iron:30w Max.
- 3 Soldering Time: 3 Sec. Max. One Time.

For Dip Soldering :

- 1 Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2 Bath Temp:265°C Max.
- 3 Dip Time:5 Sec. Max.
- 5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard LEDs - SMD category:

Click to view products by Para Light manufacturer:

Other Similar products are found below :

LTST-C190KYKT LTST-C19GD2WT LTST-N683GBEW LTW-170ZDC LTW-M140SZS40 LTW-M140ZVS 598-8110-100F 598-8170-100F 598-8610-202F AAAF5060QBFSEEZGS ALMD-LB36-SV002 APT1608QGW EAST2012YA0 EASV1803BA0 SML-512VWT86A SML-LX0606SISUGC/A SML-LXL1307SRC-TR SML-LXR851SIUPGUBC LT1ED53A AM27ZGC03 APB3025SGNC APFA3010SURKCGKQBDC APHK1608VGCA APT2012QGW CLX6D-FKB-CN1R1H1BB7D3D3 LTST-008BGEW LTW-020ZDCG LTW-21TS5 LTW-220DS5 598-8330-117F SML-LX0402IC-TR CMDA20AYAA7D1S CMDA16AYDR7A1X 91-21SYGD/S530-E2/TR7 598-8040-100F 598-8070-100F 598-8140-100F 598-8610-200F EAST2012GA0 EAPL3527GA5 SML-LXL1209SYC/ATR EAST2012RA0 CMD91-21VRC/TR7 SML-LXR851SGSIC-TR SML-512PWT86A SMF-2432GYC-TR LTST-C194TBKT-5A CLX6E-FKC-CH1M1D1BB7C3D3 SML-LXL0805USBC-TR SML-LX2835SYSUGCTR